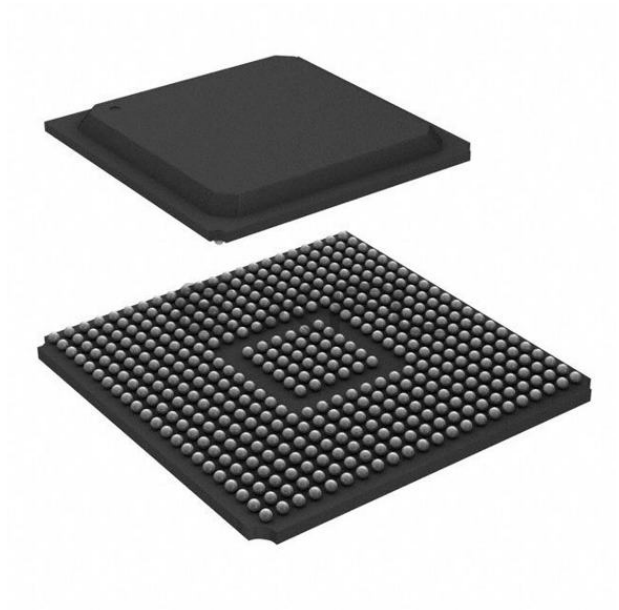

Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	768
Number of Logic Elements/Cells	-
Total RAM Bits	589824
Number of I/O	264
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v500-4fgg456i

Figure 13 provides examples illustrating the use of the LVDS_DCI and LVDSEXT_DCI I/O standards. For a complete list, see the **Virtex-II Platform FPGA User Guide**.

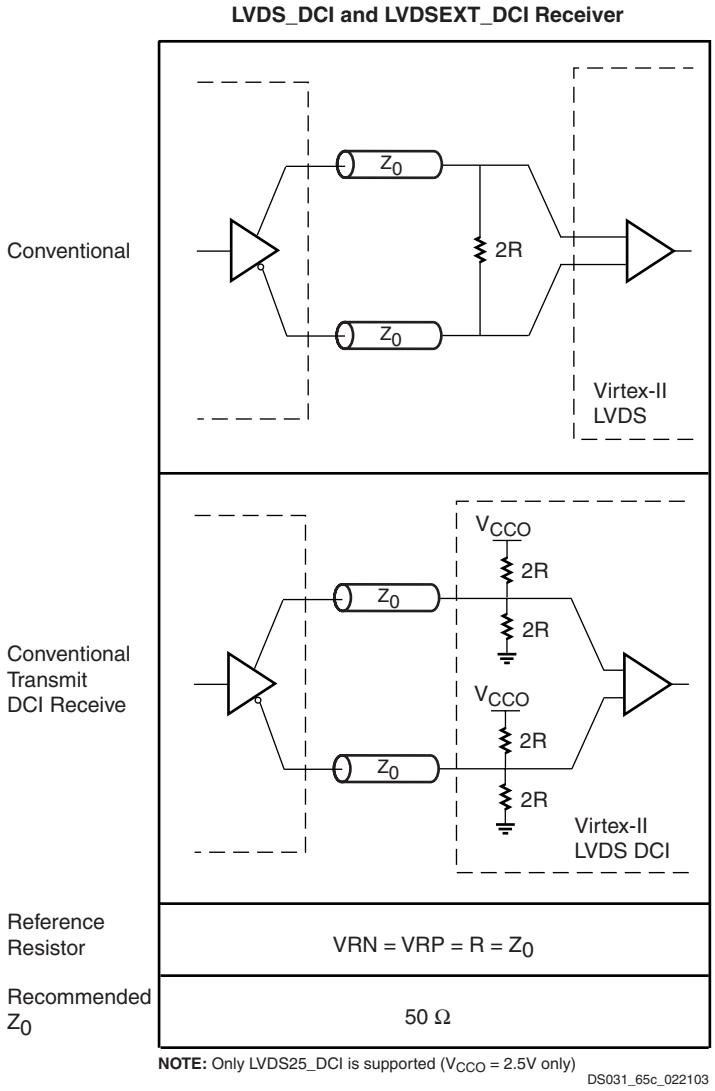

Figure 13: **LVDS DCI Usage Examples**

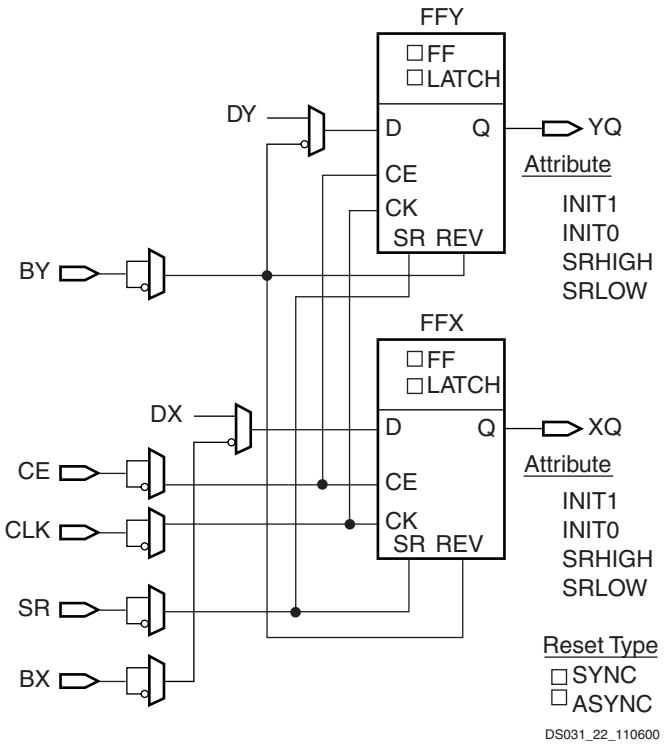

Figure 17: **Register / Latch Configuration in a Slice**

The set and reset functionality of a register or a latch can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset has precedence over a set, and an asynchronous clear has precedence over a preset.

Distributed SelectRAM Memory

Each function generator (LUT) can implement a 16 x 1-bit synchronous RAM resource called a distributed SelectRAM element. The SelectRAM elements are configurable within a CLB to implement the following:

- Single-Port 16 x 8 bit RAM
- Single-Port 32 x 4 bit RAM
- Single-Port 64 x 2 bit RAM
- Single-Port 128 x 1 bit RAM
- Dual-Port 16 x 4 bit RAM
- Dual-Port 32 x 2 bit RAM
- Dual-Port 64 x 1 bit RAM

Distributed SelectRAM memory modules are synchronous (write) resources. The combinatorial read access time is extremely fast, while the synchronous write simplifies high-speed designs. A synchronous read can be implemented with a storage element in the same slice. The distributed SelectRAM memory and the storage element share the same clock input. A Write Enable (WE) input is active High, and is driven by the SR input.

Table 9 shows the number of LUTs (2 per slice) occupied by each distributed SelectRAM configuration.

Table 9: **Distributed SelectRAM Configurations**

RAM	Number of LUTs
16 x 1S	1
16 x 1D	2
32 x 1S	2
32 x 1D	4
64 x 1S	4
64 x 1D	8
128 x 1S	8

Notes:
1. S = single-port configuration; D = dual-port configuration

For single-port configurations, distributed SelectRAM memory has one address port for synchronous writes and asynchronous reads.

For dual-port configurations, distributed SelectRAM memory has one port for synchronous writes and asynchronous reads and another port for asynchronous reads. The function generator (LUT) has separated read address inputs (A1, A2, A3, A4) and write address inputs (WG1/WF1, WG2/WF2, WG3/WF3, WG4/WF4).

In single-port mode, read and write addresses share the same address bus. In dual-port mode, one function generator (R/W port) is connected with shared read and write addresses. The second function generator has the A inputs (read) connected to the second read-only port address and the W inputs (write) shared with the first read/write port address.

Table 5: **Minimum Power On Current Required for Virtex-II Devices**

	Device (mA)							
	XC2V40, XC2V80, XC2V250, XC2V500	XC2V1000	XC2V1500	XC2V2000	XC2V3000	XC2V4000	XC2V6000	XC2V8000
$I_{CCINTMIN}$	200	250	350	400	500	650	800	1100
$I_{CCAUXMIN}$	100	100	100	100	100	100	100	100
I_{CCOMIN}	50	50	100	100	100	100	100	100

Notes:
1. Values specified for power on current parameters are Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.25.
2. I_{CCOMIN} values listed here apply to the entire device (all banks).

General Power Supply Requirements

Proper decoupling of all FPGA power supplies is sessential. Consult Xilinx Application Note **XAPP623** for detailed information on power distribution system design.

V_{CCAUX} powers critical resources in the FPGA. Thus, V_{CCAUX} is especially susceptible to power supply noise.

Changes in V_{CCAUX} voltage outside of 200 mV peak to peak should take place at a rate no faster than 10 mV per millisecond. Techniques to help reduce jitter and period distortion are provided in Xilinx Answer Record 13756, available at **www.support.xilinx.com**.

V_{CCAUX} can share a power plane with 3.3V V_{CCO}, but only if V_{CCO} does not have excessive noise. Using simultaneously switching output (SSO) limits are essential for keeping power supply noise to a minimum. Refer to **XAPP689**, "Managing Ground Bounce in Large FPGAs," to determine the number of simultaneously switching outputs allowed per bank at the package level.

DC Input and Output Levels

Values for V_{IL} and V_{IH} are recommended input voltages. Values for I_{OL} and I_{OH} are guaranteed over the recommended operating conditions at the V_{OL} and V_{OH} test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at minimum V_{CCO} with the respective V_{OL} and V_{OH} voltage levels shown. Other standards are sample tested.

Table 6: **DC Input and Output Levels**

Input/Output	V_{IL}		V_{IH}		V_{OL}	V_{OH}	I_{OL}	I_{OH}
Standard	V, Min	V, Max	V, Min	V, Max	V, Max	V, Min	mA	mA
LVTTL(1)	– 0.5	0.8	2.0	3.6	0.4	2.4	24	– 24
LVCMOS33	– 0.5	0.8	2.0	3.6	0.4	V_{CCO} – 0.4	24	– 24
LVCMOS25	– 0.5	0.7	1.7	2.7	0.4	V_{CCO} – 0.4	24	– 24
LVCMOS18	– 0.5	35% V_{CCO}	65% V_{CCO}	1.95	0.4	V_{CCO} – 0.4	16	– 16
LVCMOS15	– 0.5	35% V_{CCO}	65% V_{CCO}	1.7	0.4	V_{CCO} – 0.4	16	– 16
PCI33_3	– 0.5	30% V_{CCO}	50% V_{CCO}	V_{CCO} + 0.5	10% V_{CCO}	90% V_{CCO}	Note 2	Note 2
PCI66_3	– 0.5	30% V_{CCO}	50% V_{CCO}	V_{CCO} + 0.5	10% V_{CCO}	90% V_{CCO}	Note 2	Note 2
PCI–X	– 0.5	Note 2	Note 2	Note 2	Note 2	Note 2	Note 2	Note 2
GTLP	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.6	n/a	36	n/a
GTL	– 0.5	V_{REF} – 0.05	V_{REF} + 0.05	V_{CCO} + 0.5	0.4	n/a	40	n/a
HSTL I	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	8	– 8
HSTL II	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	16	– 16
HSTL III	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	24	– 8
HSTL IV	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	48	– 8

Clock Distribution Switching Characteristics

Table 20: **Clock Distribution Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Global Clock Buffer I input to O output	T_{GIO}	0.47	0.52	0.59	ns, Max
Global Clock Buffer S input Setup/Hold to I1 an I2 inputs	T_{GSI}/T_{GIS}	0.55/ 0	0.61/ 0	0.70/ 0	ns, Max

CLB Switching Characteristics

Delays originating at F/G inputs vary slightly according to the input used (see Figure 16 in Module 2). The values listed below are worst-case. Precise values are provided by the timing analyzer.

Table 21: **CLB Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Combinatorial Delays					
4-input function: F/G inputs to X/Y outputs	T_{ILO}	0.35	0.39	0.44	ns, Max
5-input function: F/G inputs to F5 output	T_{IF5}	0.57	0.63	0.72	ns, Max
5-input function: F/G inputs to X output	T_{IF5X}	0.76	0.83	0.95	ns, Max
FXINA or FXINB inputs to Y output via MUXFX	T_{IFXY}	0.36	0.39	0.45	ns, Max
FXINA input to FX output via MUXFX	T_{INAFX}	0.26	0.28	0.32	ns, Max
FXINB input to FX output via MUXFX	T_{INBFX}	0.26	0.28	0.32	ns, Max
SOPIN input to SOPOUT output via ORCY	T_{SOPSOP}	0.35	0.38	0.44	ns, Max
Incremental delay routing through transparent latch to XQ/YQ outputs	T_{IFNCTL}	0.41	0.45	0.51	ns, Max
Sequential Delays					
FF Clock CLK to XQ/YQ outputs	T_{CKO}	0.45	0.50	0.57	ns, Max
Latch Clock CLK to XQ/YQ outputs	T_{CKLO}	0.54	0.59	0.68	ns, Max
Setup and Hold Times Before/After Clock CLK					
BX/BY inputs	T_{DICK}/T_{CKDI}	0.30/–0.07	0.33/–0.08	0.37/–0.09	ns, Min
DY inputs	T_{DYCK}/T_{CKDY}	0.30/–0.07	0.33/–0.08	0.37/–0.09	ns, Min
DX inputs	T_{DXCK}/T_{CKDX}	0.30/–0.07	0.33/–0.08	0.37/–0.09	ns, Min
CE input	T_{CECK}/T_{CKCE}	0.19/–0.06	0.21/–0.07	0.24/–0.08	ns, Min
SR/BY inputs (synchronous)	T_{SRCK}/T_{SCKR}	0.21/–0.02	0.23/–0.03	0.26/–0.03	ns, Min
Clock CLK					
Minimum Pulse Width, High	T_{CH}	0.61	0.67	0.77	ns, Min
Minimum Pulse Width, Low	T_{CL}	0.61	0.67	0.77	ns, Min
Set/Reset					
Minimum Pulse Width, SR/BY inputs (asynchronous)	T_{RPW}	0.61	0.67	0.77	ns, Min
Delay from SR/BY inputs to XQ/YQ outputs (asynchronous)	T_{RQ}	1.06	1.17	1.34	ns, Max
Toggle Frequency (MHz) (for export control)	F_{TOG}	820	750	650	MHz

Table 3: **Virtex-II Device/Package Combinations and Maximum Number of Available I/Os**

Package	Available I/Os										
	XC2V 40	XC2V 80	XC2V 250	XC2V 500	XC2V 1000	XC2V 1500	XC2V 2000	XC2V 3000	XC2V 4000	XC2V 6000	XC2V 8000
CS144	88	92	92	-	-	-	-	-	-	-	-
FG256	88	120	172	172	172	-	-	-	-	-	-
FG456	-	-	200	264	324	-	-	-	-	-	-
FG676	-	-	-	-	-	392	456	484	-	-	-
FF896	-	-	-	-	432	528	624	-	-	-	-
FF1152	-	-	-	-	-	-	-	720	824	824	824
FF1517	-	-	-	-	-	-	-	-	912	1,104	1,108
BG575	-	-	-	-	328	392	408	-	-	-	-
BG728	-	-	-	-	-	-	-	516	-	-	-
BF957	-	-	-	-	-	-	624	684	684	684	-

Virtex-II Pin Definitions

This section describes the pinouts for Virtex-II devices in the following packages:

- CS144: wire-bond chip-scale ball grid array (BGA) of 0.80 mm pitch
- FG256, FG456, and FG676: wire-bond fine-pitch BGA of 1.00 mm pitch
- FF896, FF1152, FF1517: flip-chip fine-pitch BGA of 1.00 mm pitch
- BG575 and BG728: wire-bond BGA of 1.27 mm pitch
- BF957: flip-chip BGA of 1.27 mm pitch

All of the devices supported in a particular package are pinout compatible and are listed in the same table (one table per package). In addition, the FG456 and FG676 packages are compatible, as are the FF896 and FF1152 packages. Pins that are not available for the smallest devices are listed in right-hand columns.

Each device is split into eight I/O banks to allow for flexibility in the choice of I/O standards (see the Virtex-II *Data Sheet*). Global pins, including JTAG, configuration, and power/ground pins, are listed at the end of each table. Table 4 provides definitions for all pin types.

The FG256 pinouts (Table 6) is included as an example. All Virtex-II pinout tables are available on the distribution CD-ROM, or on the web (at **http://www.xilinx.com**).

Table 4: **Virtex-II Pin Definitions *(Continued)***

Pin Name	Direction	Description
PROG_B	Input	Active Low asynchronous reset to configuration logic. This pin has a permanent weak pull-up resistor.
DONE	Input/Output	DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, this pin indicates completion of the configuration process. As an input, a Low level on DONE can be configured to delay the start-up sequence.
M2, M1, M0	Input	Configuration mode selection.
HSWAP_EN	Input	Enable I/O pull-ups during configuration.
TCK	Input	Boundary Scan Clock.
TDI	Input	Boundary Scan Data Input.
TDO	Output	Boundary Scan Data Output.
TMS	Input	Boundary Scan Mode Select.
PWRDWN_B	Input *(unsupported)*	Active Low power-down pin (unsupported). *Driving this pin Low can adversely affect device operation and configuration.* PWRDWN_B is internally pulled High, which is its default state. It does not require an external pull-up.
Other Pins		
DXN, DXP	N/A	Temperature-sensing diode pins (Anode: DXP, Cathode: DXN).
V_{BATT}	Input	Decryptor key memory backup supply. Connect V_{BATT} to V_{CCAUX} or GND if battery is not used.
RSVD	N/A	Reserved pin - do not connect.
V_{CCO}	Input	Power-supply pins for the output drivers (per bank).
V_{CCAUX}	Input	Power-supply pins for auxiliary circuits.
V_{CCINT}	Input	Power-supply pins for the internal core logic.
GND	Input	Ground.

Notes:
1. All dedicated pins (JTAG and configuration) are powered by V_{CCAUX} (independent of the bank V_{CCO} voltage).

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
4	IO_L91N_4/VREF_4	R11	NC	NC
4	IO_L91P_4	T11	NC	NC
4	IO_L92N_4	M11	NC	NC
4	IO_L92P_4	M10	NC	NC
4	IO_L93N_4	N10	NC	NC
4	IO_L93P_4	P10	NC	NC
4	IO_L94N_4/VREF_4	R10		
4	IO_L94P_4	T10		
4	IO_L95N_4/GCLK3S	N9		
4	IO_L95P_4/GCLK2P	P9		
4	IO_L96N_4/GCLK1S	R9		
4	IO_L96P_4/GCLK0P	T9		
5	IO_L96N_5/GCLK7S	T8		
5	IO_L96P_5/GCLK6P	R8		
5	IO_L95N_5/GCLK5S	P8		
5	IO_L95P_5/GCLK4P	N8		
5	IO_L94N_5	T7		
5	IO_L94P_5/VREF_5	R7		
5	IO_L93N_5	P7	NC	NC
5	IO_L93P_5	N7	NC	NC
5	IO_L92N_5	M7	NC	NC
5	IO_L92P_5	M6	NC	NC
5	IO_L91N_5	T6	NC	NC
5	IO_L91P_5/VREF_5	R6	NC	NC
5	IO_L05N_5/VRP_5	P6	NC	NC
5	IO_L05P_5/VRN_5	N6	NC	NC
5	IO_L04N_5	T5	NC	NC
5	IO_L04P_5/VREF_5	R5	NC	NC
5	IO_L03N_5/D4/ALT_VRP_5	P5		
5	IO_L03P_5/D5/ALT_VRN_5	N5		
5	IO_L02N_5/D6	R4		
5	IO_L02P_5/D7	P4		
5	IO_L01N_5/RDWR_B	T4		

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
5	IO_L06P_5	W6		
5	IO_L05N_5/VRP_5	V7		
5	IO_L05P_5/VRN_5	V6		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	Y5		
5	IO_L03P_5/D5/ALT_VRN_5	W5		
5	IO_L02N_5/D6	AB4		
5	IO_L02P_5/D7	AA4		
5	IO_L01N_5/RDWR_B	Y4		
5	IO_L01P_5/CS_B	AA3		
6	IO_L01P_6	V5		
6	IO_L01N_6	U5		
6	IO_L02P_6/VRN_6	Y2		
6	IO_L02N_6/VRP_6	Y1		
6	IO_L03P_6	V4		
6	IO_L03N_6/VREF_6	V3		
6	IO_L04P_6	W2		
6	IO_L04N_6	W1		
6	IO_L06P_6	U4		
6	IO_L06N_6	U3		
6	IO_L19P_6	V2	NC	NC
6	IO_L19N_6	V1	NC	NC
6	IO_L21P_6	U2	NC	NC
6	IO_L21N_6/VREF_6	U1	NC	NC
6	IO_L22P_6	T5	NC	NC
6	IO_L22N_6	R5	NC	NC
6	IO_L24P_6	T4	NC	NC
6	IO_L24N_6	T3	NC	NC
6	IO_L43P_6	T2		
6	IO_L43N_6	T1		
6	IO_L45P_6	R4		
6	IO_L45N_6/VREF_6	R3		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	GND	L11		
NA	GND	L10		
NA	GND	K17		
NA	GND	K16		
NA	GND	K15		
NA	GND	K14		
NA	GND	K13		
NA	GND	K12		
NA	GND	K11		
NA	GND	K10		
NA	GND	F21		
NA	GND	F6		
NA	GND	E22		
NA	GND	E5		
NA	GND	D23		
NA	GND	D4		
NA	GND	C24		
NA	GND	C3		
NA	GND	B25		
NA	GND	B14		
NA	GND	B13		
NA	GND	B2		
NA	GND	A26		
NA	GND	A1		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L69P_0/VREF_0	B9	NC	
0	IO_L70N_0	F10	NC	
0	IO_L70P_0	E10	NC	
0	IO_L72N_0	A10	NC	
0	IO_L72P_0	A11	NC	
0	IO_L73N_0	C10	NC	NC
0	IO_L73P_0	B10	NC	NC
0	IO_L91N_0/VREF_0	D11		
0	IO_L91P_0	C11		
0	IO_L92N_0	G11		
0	IO_L92P_0	E11		
0	IO_L93N_0	C12		
0	IO_L93P_0	B12		
0	IO_L94N_0/VREF_0	E12		
0	IO_L94P_0	D12		
0	IO_L95N_0/GCLK7P	G12		
0	IO_L95P_0/GCLK6S	F12		
0	IO_L96N_0/GCLK5P	H11		
0	IO_L96P_0/GCLK4S	H12		
1	IO_L96N_1/GCLK3P	A13		
1	IO_L96P_1/GCLK2S	A14		
1	IO_L95N_1/GCLK1P	B13		
1	IO_L95P_1/GCLK0S	C13		
1	IO_L94N_1	D13		
1	IO_L94P_1/VREF_1	E13		
1	IO_L93N_1	F13		
1	IO_L93P_1	G13		
1	IO_L92N_1	H13		
1	IO_L92P_1	H14		
1	IO_L91N_1	C14		
1	IO_L91P_1/VREF_1	D14		
1	IO_L73N_1	E14	NC	NC
1	IO_L73P_1	G14	NC	NC
1	IO_L72N_1	A15	NC	
1	IO_L72P_1	A16	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
6	IO_L91N_6	P4		
6	IO_L93P_6	N4		
6	IO_L93N_6/VREF_6	N3		
6	IO_L94P_6	N6		
6	IO_L94N_6	N5		
6	IO_L96P_6	N8		
6	IO_L96N_6	N7		
7	IO_L96P_7	N2		
7	IO_L96N_7	M1		
7	IO_L94P_7	M2		
7	IO_L94N_7	M3		
7	IO_L93P_7/VREF_7	M4		
7	IO_L93N_7	M5		
7	IO_L91P_7	M6		
7	IO_L91N_7	M7		
7	IO_L73P_7	M8	NC	NC
7	IO_L73N_7	L8	NC	NC
7	IO_L72P_7	L1	NC	
7	IO_L72N_7	K1	NC	
7	IO_L70P_7	K2	NC	
7	IO_L70N_7	K3	NC	
7	IO_L69P_7/VREF_7	L3	NC	
7	IO_L69N_7	L4	NC	
7	IO_L67P_7	L5	NC	
7	IO_L67N_7	L7	NC	
7	IO_L54P_7	J1		
7	IO_L54N_7	H1		
7	IO_L52P_7	J2		
7	IO_L52N_7	J3		
7	IO_L51P_7/VREF_7	J4		
7	IO_L51N_7	J5		
7	IO_L49P_7	K5		
7	IO_L49N_7	K6		
7	IO_L48P_7	F1		
7	IO_L48N_7	F2		

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L52P_7	J29		
7	IO_L52N_7	K29		
7	IO_L51P_7/VREF_7	K27		
7	IO_L51N_7	J27		
7	IO_L50P_7	L24		
7	IO_L50N_7	K24		
7	IO_L49P_7	H27		
7	IO_L49N_7	J28		
7	IO_L48P_7	H26		
7	IO_L48N_7	J26		
7	IO_L47P_7	K25		
7	IO_L47N_7	J25		
7	IO_L46P_7	H28		
7	IO_L46N_7	H29		
7	IO_L45P_7/VREF_7	G28		
7	IO_L45N_7	F28		
7	IO_L44P_7	L23		
7	IO_L44N_7	K23		
7	IO_L43P_7	F30		
7	IO_L43N_7	G30		
7	IO_L24P_7	F26		
7	IO_L24N_7	G27		
7	IO_L23P_7	J24		
7	IO_L23N_7	H24		
7	IO_L22P_7	F29		
7	IO_L22N_7	G29		
7	IO_L21P_7/VREF_7	G26		
7	IO_L21N_7	G25		
7	IO_L20P_7	H25		
7	IO_L20N_7	G24		
7	IO_L19P_7	D30		
7	IO_L19N_7	E30		
7	IO_L06P_7	E27		
7	IO_L06N_7	F27		
7	IO_L05P_7	J23		
7	IO_L05N_7	H22		
7	IO_L04P_7	C29		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L95P_6	W30	
6	IO_L95N_6	V30	
6	IO_L96P_6	V32	
6	IO_L96N_6	W32	
7	IO_L96P_7	U31	
7	IO_L96N_7	V31	
7	IO_L95P_7	T28	
7	IO_L95N_7	U28	
7	IO_L94P_7	U33	
7	IO_L94N_7	U34	
7	IO_L93P_7/VREF_7	U29	
7	IO_L93N_7	T29	
7	IO_L92P_7	U27	
7	IO_L92N_7	U26	
7	IO_L91P_7	T30	
7	IO_L91N_7	U30	
7	IO_L84P_7	R32	NC
7	IO_L84N_7	T32	NC
7	IO_L83P_7	U25	NC
7	IO_L83N_7	T25	NC
7	IO_L82P_7	R34	NC
7	IO_L82N_7	T33	NC
7	IO_L81P_7/VREF_7	N34	NC
7	IO_L81N_7	P34	NC
7	IO_L80P_7	U24	NC
7	IO_L80N_7	T24	NC
7	IO_L79P_7	R31	NC
7	IO_L79N_7	T31	NC
7	IO_L78P_7	N32	
7	IO_L78N_7	P32	
7	IO_L77P_7	T27	
7	IO_L77N_7	R27	
7	IO_L76P_7	N33	
7	IO_L76N_7	P33	
7	IO_L75P_7/VREF_7	R29	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L82N_3	AA4		
3	IO_L82P_3	AB4		
3	IO_L81N_3/VREF_3	AB11		
3	IO_L81P_3	AA11		
3	IO_L80N_3	AC1		
3	IO_L80P_3	AD1		
3	IO_L79N_3	AA7		
3	IO_L79P_3	AB7		
3	IO_L78N_3	AB12		
3	IO_L78P_3	AA12		
3	IO_L77N_3	AC2		
3	IO_L77P_3	AC3		
3	IO_L76N_3	AB5		
3	IO_L76P_3	AC5		
3	IO_L75N_3/VREF_3	AD9		
3	IO_L75P_3	AC9		
3	IO_L74N_3	AD2		
3	IO_L74P_3	AE2		
3	IO_L73N_3	AB6		
3	IO_L73P_3	AC6		
3	IO_L72N_3	AD10		
3	IO_L72P_3	AC10		
3	IO_L71N_3	AD3		
3	IO_L71P_3	AE3		
3	IO_L70N_3	AC7		
3	IO_L70P_3	AD7		
3	IO_L69N_3/VREF_3	AE8		
3	IO_L69P_3	AD8		
3	IO_L68N_3	AE1		
3	IO_L68P_3	AF1		
3	IO_L67N_3	AD4		
3	IO_L67P_3	AE4		
3	IO_L60N_3	AD12		
3	IO_L60P_3	AC12		
3	IO_L59N_3	AF3		
3	IO_L59P_3	AG3		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L79N_5	AV24		
5	IO_L79P_5	AV23		
5	IO_L78N_5	AP23		
5	IO_L78P_5	AP22		
5	IO_L77N_5	AJ21		
5	IO_L77P_5	AJ22		
5	IO_L76N_5	AU24		
5	IO_L76P_5	AU23		
5	IO_L75N_5/VREF_5	AT25		
5	IO_L75P_5	AT24		
5	IO_L74N_5	AH21		
5	IO_L74P_5	AH22		
5	IO_L73N_5	AW26		
5	IO_L73P_5	AW25		
5	IO_L72N_5	AR25		
5	IO_L72P_5	AR24		
5	IO_L71N_5	AN23		
5	IO_L71P_5	AN24		
5	IO_L70N_5	AU25		
5	IO_L70P_5	AV25		
5	IO_L69N_5/VREF_5	AL24		
5	IO_L69P_5	AL23		
5	IO_L68N_5	AK23		
5	IO_L68P_5	AK24		
5	IO_L67N_5	AU27		
5	IO_L67P_5	AU26		
5	IO_L60N_5	AP25		
5	IO_L60P_5	AP24		
5	IO_L59N_5	AM24		
5	IO_L59P_5	AM25		
5	IO_L58N_5	AW28		
5	IO_L58P_5	AW27		
5	IO_L57N_5/VREF_5	AT27		
5	IO_L57P_5	AT26		
5	IO_L56N_5	AH23		
5	IO_L56P_5	AH24		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L55N_5	AV28		
5	IO_L55P_5	AV27		
5	IO_L54N_5	AP27		
5	IO_L54P_5	AP26		
5	IO_L53N_5	AN25		
5	IO_L53P_5	AN26		
5	IO_L52N_5	AU29		
5	IO_L52P_5	AU28		
5	IO_L51N_5/VREF_5	AR28		
5	IO_L51P_5	AR27		
5	IO_L50N_5	AJ24		
5	IO_L50P_5	AJ25		
5	IO_L49N_5	AW30		
5	IO_L49P_5	AW29		
5	IO_L36N_5	AT29	NC	
5	IO_L36P_5	AT28	NC	
5	IO_L35N_5	AK25	NC	
5	IO_L35P_5	AL26	NC	
5	IO_L34N_5	AV31	NC	
5	IO_L34P_5	AV30	NC	
5	IO_L33N_5/VREF_5	AP29	NC	
5	IO_L33P_5	AP28	NC	
5	IO_L32N_5	AK26	NC	
5	IO_L32P_5	AJ26	NC	
5	IO_L31N_5	AW32	NC	
5	IO_L31P_5	AW31	NC	
5	IO_L30N_5	AM27		
5	IO_L30P_5	AM26		
5	IO_L29N_5	AN28		
5	IO_L29P_5	AN29		
5	IO_L28N_5	AU31		
5	IO_L28P_5	AU30		
5	IO_L27N_5/VREF_5	AT31		
5	IO_L27P_5	AT30		
5	IO_L26N_5	AH25		
5	IO_L26P_5	AH26		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L50P_7	P32		
7	IO_L50N_7	N32		
7	IO_L49P_7	L37		
7	IO_L49N_7	M37		
7	IO_L48P_7	N34		
7	IO_L48N_7	P34		
7	IO_L47P_7	P31		
7	IO_L47N_7	N31		
7	IO_L46P_7	M35		
7	IO_L46N_7	N35		
7	IO_L45P_7/VREF_7	L36		
7	IO_L45N_7	M36		
7	IO_L44P_7	R28		
7	IO_L44N_7	P28		
7	IO_L43P_7	K39		
7	IO_L43N_7	L39		
7	IO_L36P_7	L34	NC	
7	IO_L36N_7	M34	NC	
7	IO_L35P_7	P29	NC	
7	IO_L35N_7	N29	NC	
7	IO_L34P_7	J38	NC	
7	IO_L34N_7	K38	NC	
7	IO_L33P_7/VREF_7	L33	NC	
7	IO_L33N_7	M33	NC	
7	IO_L32P_7	M32	NC	
7	IO_L32N_7	L32	NC	
7	IO_L31P_7	H39	NC	
7	IO_L31N_7	J39	NC	
7	IO_L30P_7	J36		
7	IO_L30N_7	K36		
7	IO_L29P_7	N30		
7	IO_L29N_7	M30		
7	IO_L28P_7	J37		
7	IO_L28N_7	K37		
7	IO_L27P_7/VREF_7	J35		
7	IO_L27N_7	K35		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
2	IO_L23N_2	E2	
2	IO_L23P_2	F2	
2	IO_L24N_2	H4	
2	IO_L24P_2	J4	
2	IO_L25N_2	K8	NC
2	IO_L25P_2	L8	NC
2	IO_L27N_2	J7	NC
2	IO_L27P_2/VREF_2	K7	NC
2	IO_L43N_2	F1	
2	IO_L43P_2	G1	
2	IO_L44N_2	L9	
2	IO_L44P_2	M9	
2	IO_L45N_2	G2	
2	IO_L45P_2/VREF_2	J2	
2	IO_L46N_2	H3	
2	IO_L46P_2	J3	
2	IO_L47N_2	J6	
2	IO_L47P_2	L6	
2	IO_L48N_2	J5	
2	IO_L48P_2	K5	
2	IO_L49N_2	H1	
2	IO_L49P_2	J1	
2	IO_L50N_2	N10	
2	IO_L50P_2	P10	
2	IO_L51N_2	L7	
2	IO_L51P_2/VREF_2	M7	
2	IO_L52N_2	K3	
2	IO_L52P_2	L3	
2	IO_L53N_2	M8	
2	IO_L53P_2	N8	
2	IO_L54N_2	L5	
2	IO_L54P_2	M5	
2	IO_L67N_2	K2	
2	IO_L67P_2	L2	
2	IO_L68N_2	M6	
2	IO_L68P_2	N6	
2	IO_L69N_2	L4	
2	IO_L69P_2/VREF_2	M4	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	VCCINT	T21	
NA	VCCINT	U10	
NA	VCCINT	U13	
NA	VCCINT	U19	
NA	VCCINT	U22	
NA	VCCINT	V13	
NA	VCCINT	V19	
NA	VCCINT	W13	
NA	VCCINT	W14	
NA	VCCINT	W15	
NA	VCCINT	W16	
NA	VCCINT	W17	
NA	VCCINT	W18	
NA	VCCINT	W19	
NA	VCCINT	Y12	
NA	VCCINT	Y16	
NA	VCCINT	Y20	
NA	VCCINT	AA11	
NA	VCCINT	AA16	
NA	VCCINT	AA21	
NA	VCCINT	AB15	
NA	VCCINT	AB17	
NA	GND	A2	
NA	GND	A3	
NA	GND	A16	
NA	GND	A29	
NA	GND	A30	
NA	GND	B1	
NA	GND	B2	
NA	GND	B8	
NA	GND	B24	
NA	GND	B30	
NA	GND	B31	
NA	GND	C1	
NA	GND	C3	
NA	GND	C29	
NA	GND	C31	
NA	GND	D4	